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09-06-2005

FORM PTO-1595	1EEI U.S. DEPARTMENT OF COMMERCE			
FORM PTO-1595 1/31/92 1.03074423	Patent and Trademark Office			
To the Honorable Commissioner of Patents and Trademarks: H	rd the attached original documents or copy thereof.			
Name of conveying party(ies)	2. Name and address of receiving party(ies): Name: Sony Corporation			
ATSUSHI TODA HIROFUMI SUMI	Internal Address:			
Additional name(s) of conveying party(ies) attached? ☐ Yes ☑ No	Internal Address:			
3. Nature of conveyance: ☐ Assignment ☐ Merger	Shinagawa-ku, Tokyo, Japan			
☐ Security Agreement ☐ Change of Name ☐ Other	City: State: Zip:			
Execution Date 8/22/05 and 8/22/05 4. Application (number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: 8/22/05 and 8/22/05				
A. Patent Application No.(s)	B: Patent No.(s)			
Attorney Docket No. 09792909-6296				
Additional numbers attached? □ Yes ⊠ No				
5. Name and address of party to whom correspondence concerning document should be	6. Total number of applications and patents involved 1			
mailed:	7. Total Fee (37 CFR 3.41 \$ 40.00 □Enclosed			
SONNENSCHEIN NATH & ROSENTHAL LLP P.O. Box #061080	■ Authorized to be charged to applicants' attorneys' American Express account. Form 2038 is			
Wacker Drive Station	attached for that purpose.			
Sears Tower Chicago, IL 60606-1080	Any deficiency is authorized to be charged to deposit account or any additional fees			
Customer ID No. 26263	8. Deposit Account Number: 19.3140 (Attach duplicate copy of this page if paying by deposit account)			
DO NOT USE THIS SPACE	(Attach duplicate copy of this page if paying by deposit account)			
9. Statement and signature:				
a true copy of the original document.	information is true and correct and any attached copy is			
David R. Metzger Name of Person Signing Signature August 25, 2005 Date				
name or resont Signing Signatu	re / Date Total number of pages 2			
Mail documents to be recorded and required cover sheet information to: Commissioner for Patents				
Mail Stop Assignment Recordation Services				
P.O. Box 1450 Alexandria, VA 22313-1450				

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PATENT REEL: 016934 FRAME: 0552

ASSIGNMENT

Docket Number: 09792909-6296

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

INFORMATION ACQUIRING METHOD, INFORMATION ACQUIRING APPARATUS, SEMICONDUCTOR DEVICE COMPRISING ARRAY OF PLURALITY OF UNIT COMPONENTS FOR DETECTING PHYSICAL QUANTITY DISTRIBUTION, AND SEMICONDUCTOR MANUFACTURING METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 7-35 Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

	ord in this application to insert the serial number and filing date of this, Filing Date:
This assignment executed on the dates indicated below.	
Atsushi TODA	
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of First or sole inventor	
Atsushi Joda	August 22, 2005
Signature of first or sole inventor	Date of this assignment
Hirofumi SUMI	
Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of second inventor	
Historie Sumo	Aug. 22, 2005
Signature of second inventor	Date of this assignment

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PATENT REEL: 016934 FRAME: 0553

RECORDED: 08/25/2005